

### **Company Introduction**

CCP Contact Probes Co., Ltd.

# **History**

2020 Korea Subsidiary established.

2019 Japan Singapore Sub and India Office established.

2018 Germany Subsidiary established.

2016 Industrial Connector & Crown Spring Connector.

2014 CCP US Subsidiary established.

2012 Set up 100k class clean room production line.

2006 IC Testing

2003 Listed in Taiwan Stock Market (TW.6217).

2002 Pogo Pin Connector

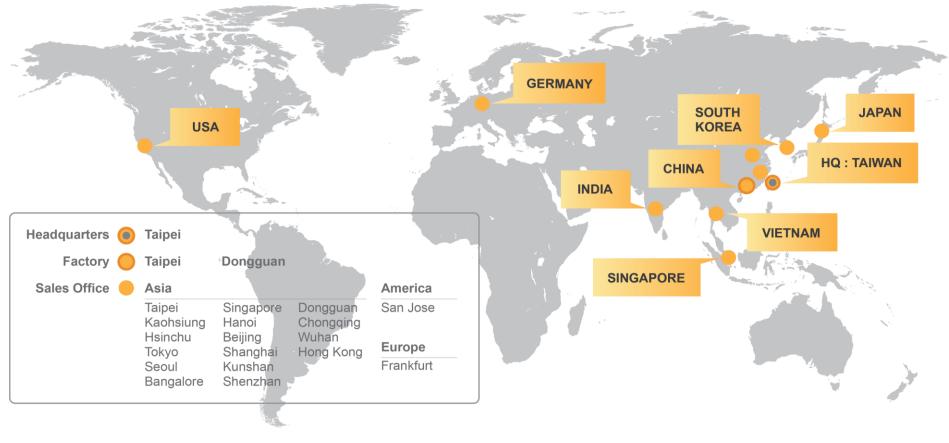
2001 Dongguan CCP Contact Probes Co., Ltd established.

1998 Renamed to CCP Contact Probes Co., Ltd.

1986 ICT Testing

1986 CCP Contact Probes Enterprise Co., Ltd. Established.

# **CCP Contact Probes**



Digita Google amazon Advantest flex Microchip

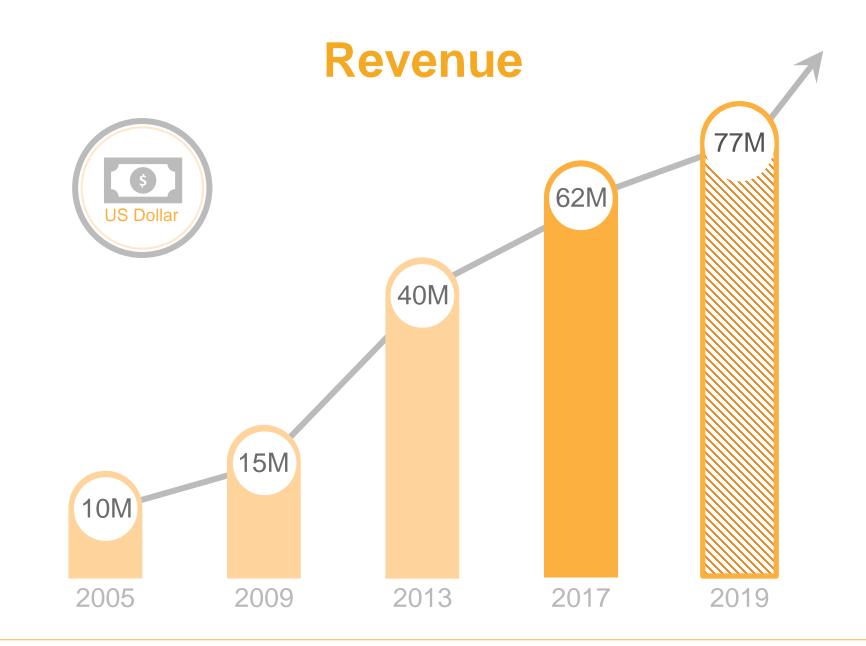
SKYWORKS

#### Selected Customers:

Microsoft

**CCP** - Group

FOXCONN



# Staff: R&D Design Service





#### **Fundamental Research**

IC Testing probe Engineer	9
MEMS Team	7
Plating Lab	6
FAE	3
Automation Engineer	4
IC Socket Design	2



### **Applied Research**

Pin & Connector R&D	15
Testing Lab	2
FAE	2
Sample Team	8
Fixture Team	1
Coating Lab	2

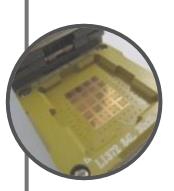
### Project Management

Project Manager	7
Engineer PM	6

# **Plating:** Comparison

Plating	Testing standard	Au(50u") Layer	AP Layer	APII Layer	Super AP Layer
Color	/	Gold	Silver	Silver	Silver
Nickel release	EN 12472:2005+A1 :2009	Nickel-containing process	Nickel-free process	Nickel-free process	Nickel-free process
Plating thickness (micro inch)	XRF	100~170	110-170	270~400	210~400
Impedance (m $\Omega$ )	EIA-364-23	< 50	< 50	< 50	< 50
Salt Spray resistance (HR)	EIA-362-26	96	48	96	168
Artificial Sweat resistance (HR)	ISO-3160	96	48	96	168
Surface hardness (HV)	ISO 6507- 1:2005	200	400	400	400
Electrolysis resistance time	1mA,5V,Pitch=0 .60mm	<1min	10min	15min	60min
Cost	Factor to Gold Plating	1	x0.9	x2	x3

# **Product Portfolio**



### **CCP** - Testing

IC Testing Probe IC Probe Head PCB Testing Probe MEMS Probe



# CCP - High Current

Electronic Vehicle High Current Conn.



CCP - Connector

Pogo Pin Conn. Waterproof Conn. Magnetic Conn.



### CCP - Industrial Extreme Environment

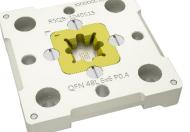
Aerospace Military Transportation Space

# **Product Line:** Testing

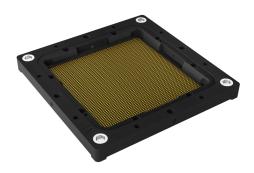


IC Package Test

Test Burn-In Test



High Frequency Test



Memory Test

WLCSP Test

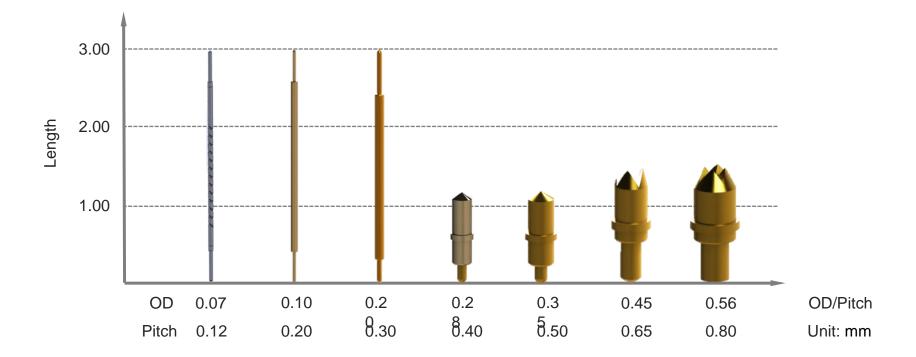
**Battery Test** 





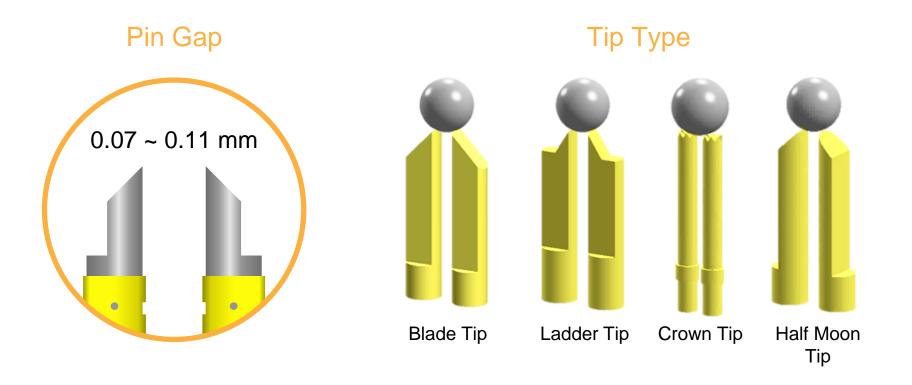


# **Testing:** Probe Design Capability



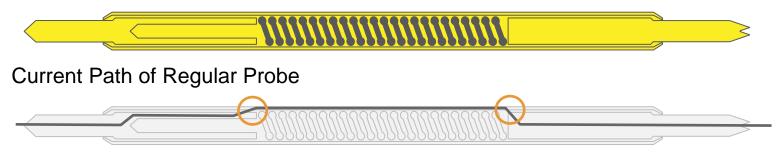
# **Testing:** Kelvin Bridge Probe

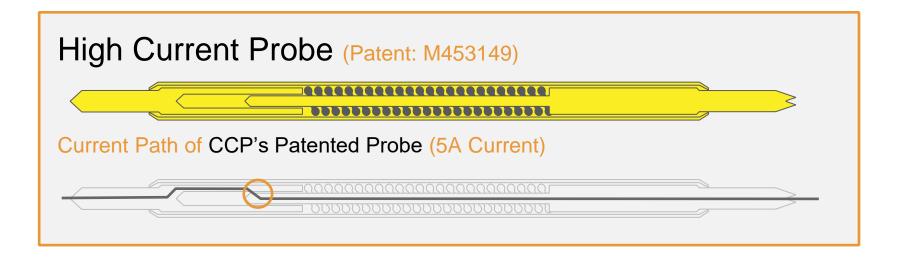
Our testing probe can be in Kelvin bridge style to increase the accuracy of probing.



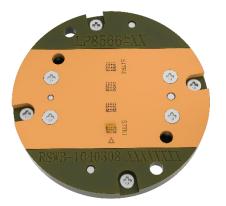
# **Testing:** High Current Probe

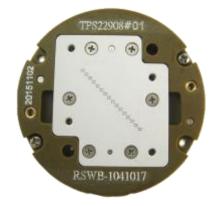
### **Regular Probe**





# **Testing:** WLCSP







36 Balls 4 Sites Pitch 0.4mm

4 Balls 16 Sites Pitch 0.5mm 12 Balls 16 Sites Pitch 0.4mm

# **Testing:** IC Final Test Socket

BGA

QFN





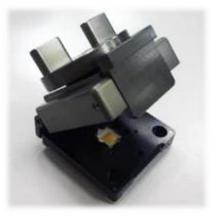
Memory Test

DDR 1~4 eMCP Flash





#### Clamping Lid QFN QFP <200 pins



Knob Lid All Kind >200 pins

# **Testing:** Coaxial Socket for RF

Application Feature: Hi-Speed/Hi-Frequency DUT: Bluetooth/ GPS/ LTE/ Wireless IC Packaging: BGA/ CSP/ QFN/ QFP **Pin Definition** Signal GGGG **G** Ground GSSG GGGG Spec: Insertion Loss: -1dB @ >50 GHz Return Loss: -20dB @ >30 GHz Impedance: 50 Ohm

Pitch: 0.65~1.00 mm



P

# **Testing:** Testing Socket

### Dual-Side Pogo Socket

Min Pitch: 0.2 Mechanical Life: 200k Clip Pogo Socket

Min Pitch: 0.2 Mechanical Life: 200k

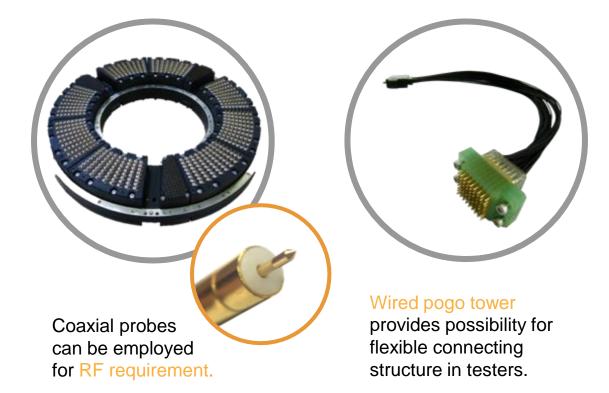
Device Under Test Fine Pitch Connector Device Under Test FPC Gold Finger

# **Testing:** Pogo Tower

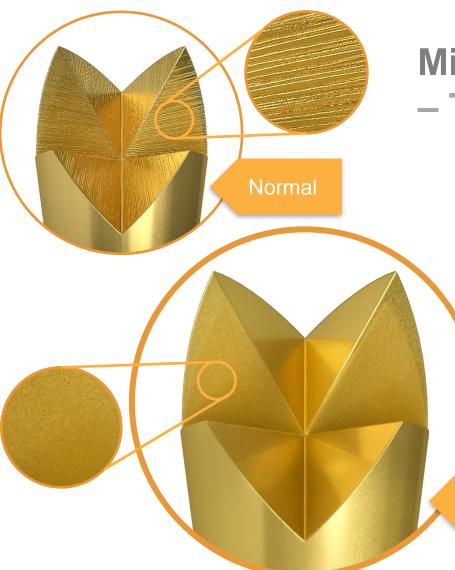
A Pogo tower is used to connect load board and mother board inside the tester.



To fit the structure of clients' tester, we customize the design of our pogo tower.



# **Testing:** Mirror Process



### Mirror Process – The Best Probe Protector

- The Mirror Process make the surface as smooth as mirror so that solder splashes won't attach on the probe tip. This, in turn, decreases your probe cleaning frequency, as well as machine down time significantly.
- Pin durability increase 1.3~1.5 times as compared to normal process.

CCP's Mirror Process

# **Product Line:** Connector



### Pogo Pin Connector



### 2 in 1 Tablet Connector



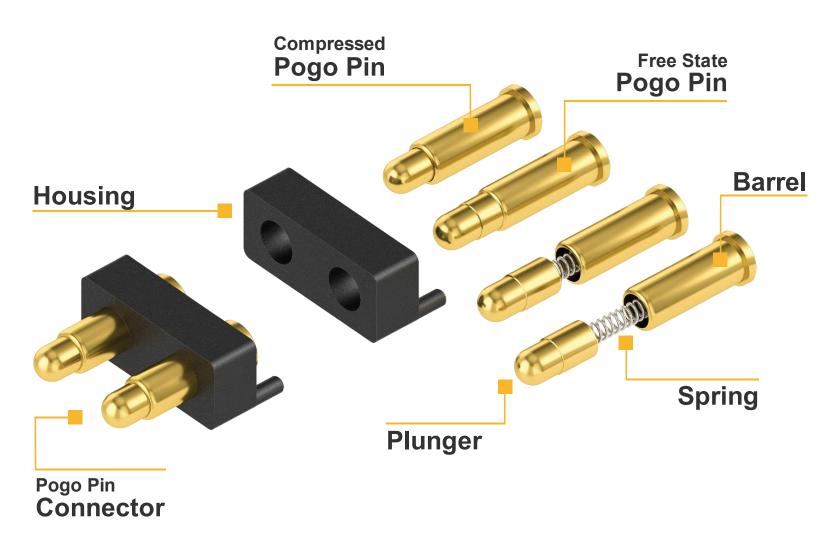
### Magnetic Connector



### Waterproof Connector



### **Connector:** Basic Structure



# **Connector:** Manufacturing



**100% inspection** can be done in automated production line. First ever clean room pogo pin production line in industry.

Dimension



# **Connector:** Inner Structure

### **Back Drill**

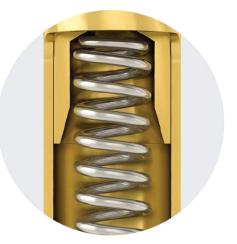
The drilled tail makes extra space for spring and creates a shorter pogo pin.

### **Bias Tail**

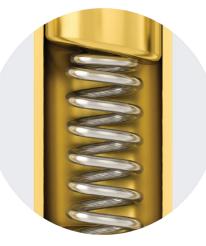
The bias tail of plunger creates lateral force and better contact.

### Ball

The ball inside stabilizes the contacting areas for a better performance.



Pin Length: ≈ 2.5 mm Current: **1 A** 

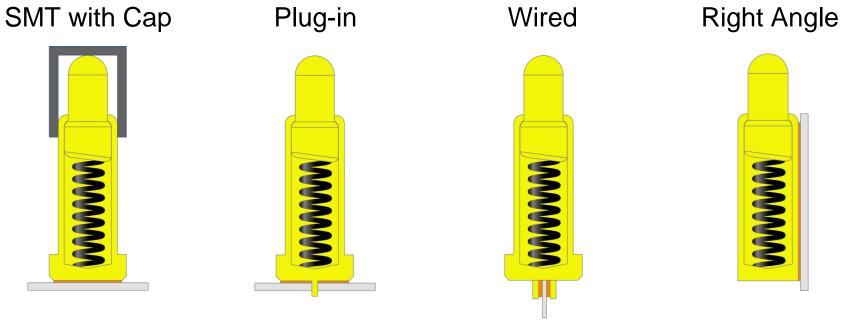


Pin Length: ≈ 3.5 mm Current: **2 A** 



Pin Length: ≈ 4.5 mm Current: **3~5 A** 

# **Connector:** Installation



Cap is used for SMT procedure, and it will be removed after being mounted. Plug-in tail is used for higher soldering force on PCB when it's needed.

Wire can be soldered onto a drilled dip for cable module. Side of square tube can be soldering area for different mechanical structure.

PCB/ Wire

Plastic Cap



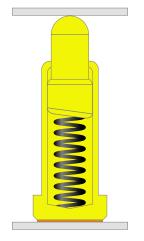
# **Connector:** Installation

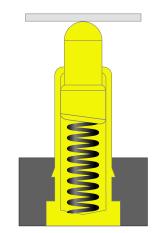
### Board to Board

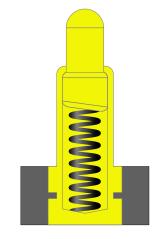
### Case to Board

### Insert-molding

**Double Ended** 

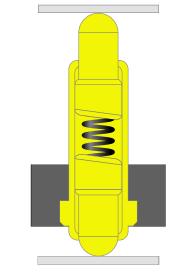






This structure is used to absorb the tolerance inbetween PCBs. The bottom of pin can also be a cosmetic/contact area if necessary.

Pins can be insertmolded for waterproofing requirement.



It's possible to have two movable tips.

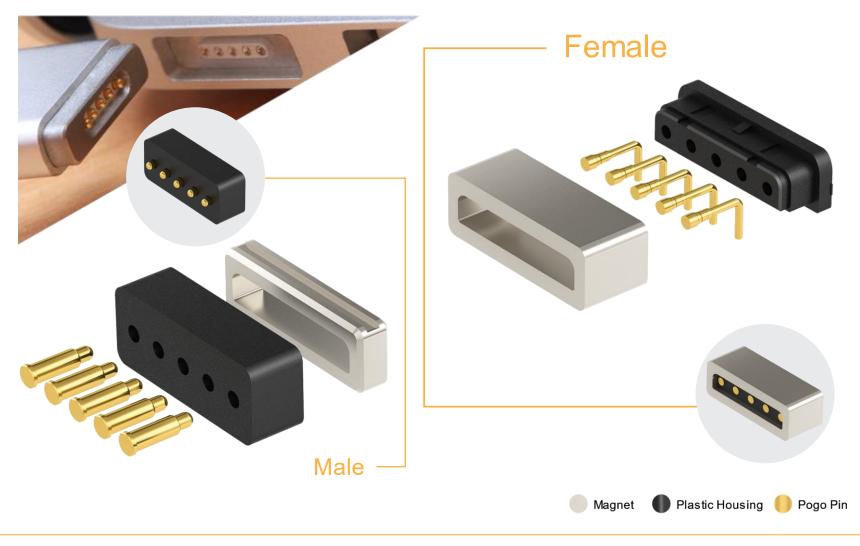


**Plastic Housing** 





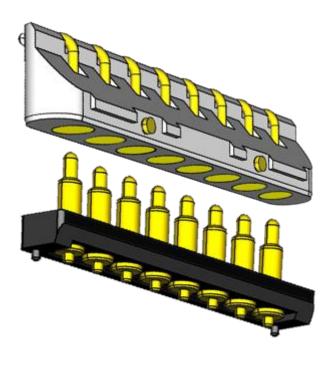
### **Connector:** Magnetic



CCP – Connector: Magnetic

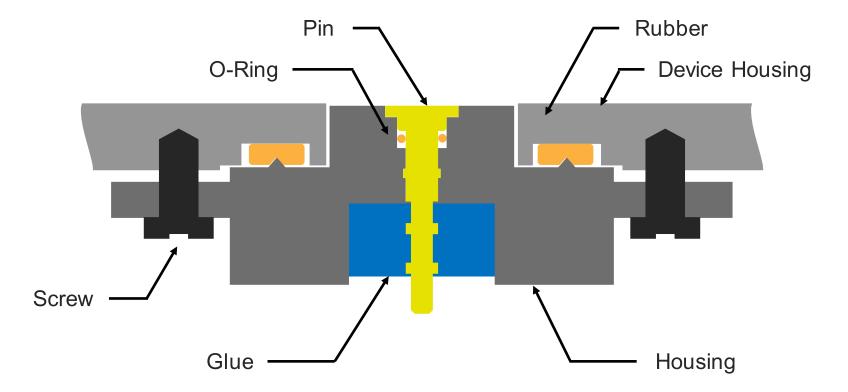
# Connector: 2 in 1 Laptop

High Frequency Magnetic Matting Desktop Docking





# **Connector:** Waterproof



# **Connector:** Waterproof

### Sealing

### **Insert-Molding**

### **O-Ring**







Pitch: Small Waterproof: IPx7 at best Production Complexity: Low Pitch: Small Waterproof: IPx7 at best Production Complexity: Low Pitch: Large Waterproof: IPx8 at best Production Complexity: High

# **Connector:** Customized



### **Magnetic Modules**

Easy attachable and detachable connectors used for different applications



#### **Rugged Modules**

Able to achieve IP67 rating and to operate under extreme environments



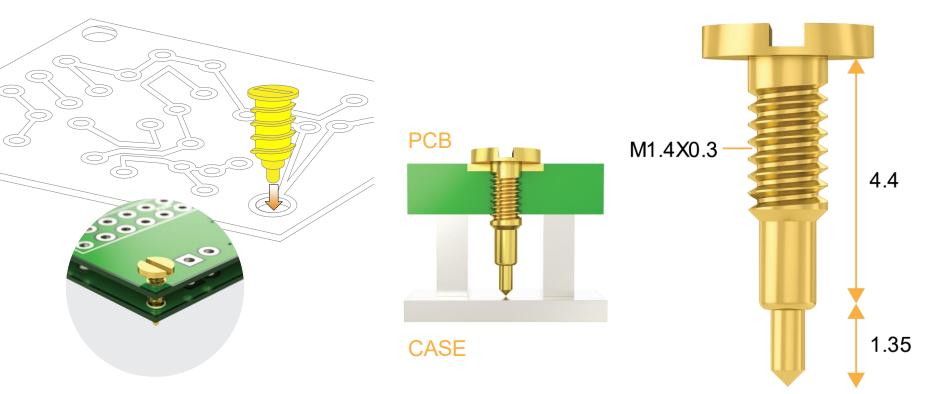


#### **Shielded Modules**

Shielded design for high speed signal transmission

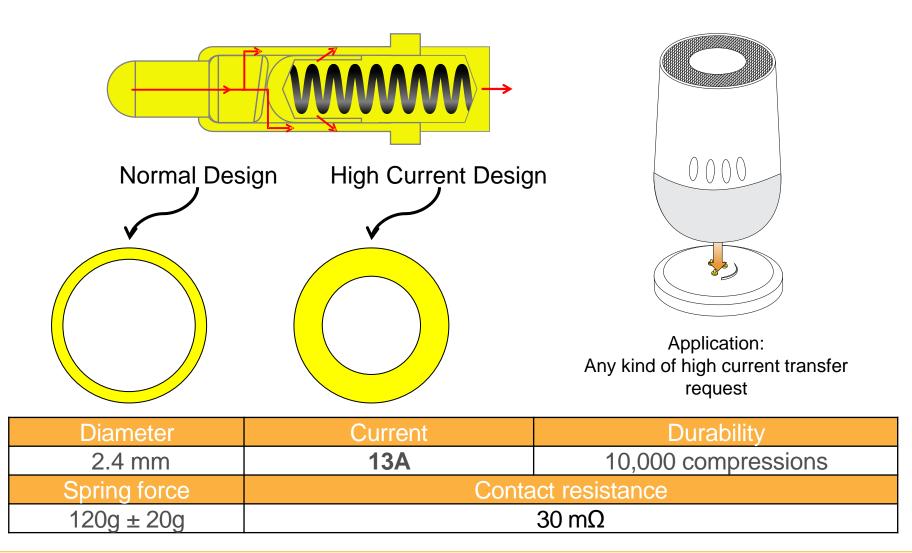


# **Connector:** Pogo Screw Pin

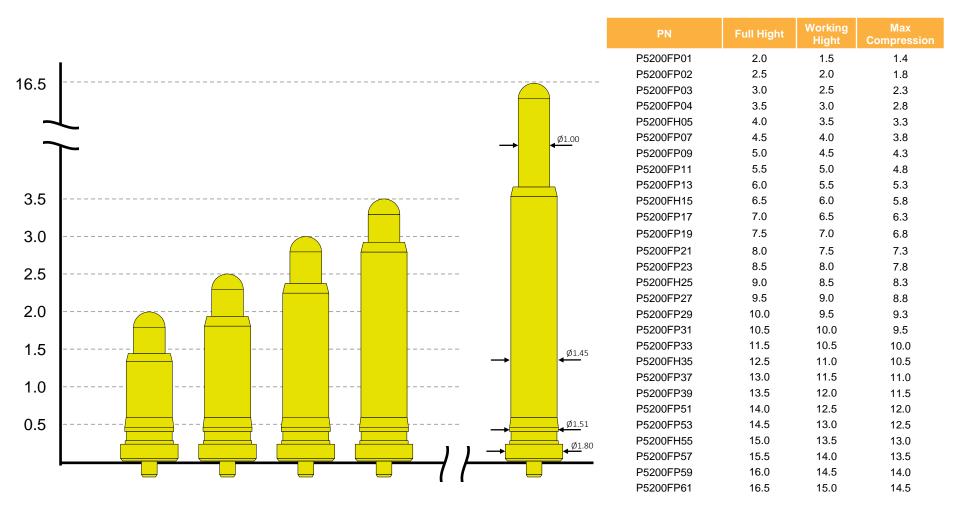


Diameter	Current	Durability	
3 mm	1A	10,000 compressions	
Spring force	Contact resistance		
120g ± 20g	200 m $\Omega$ , to customize for grounding pin purpose		

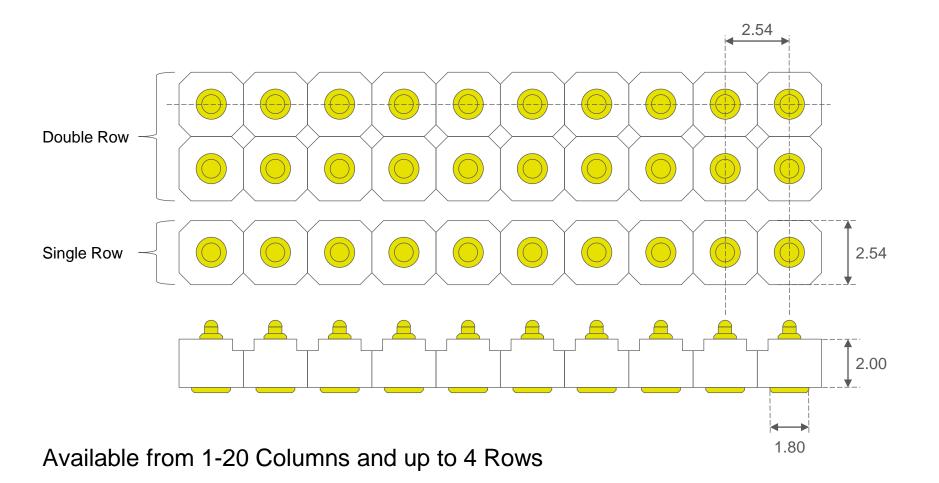
# **Connector:** High Current Pogo



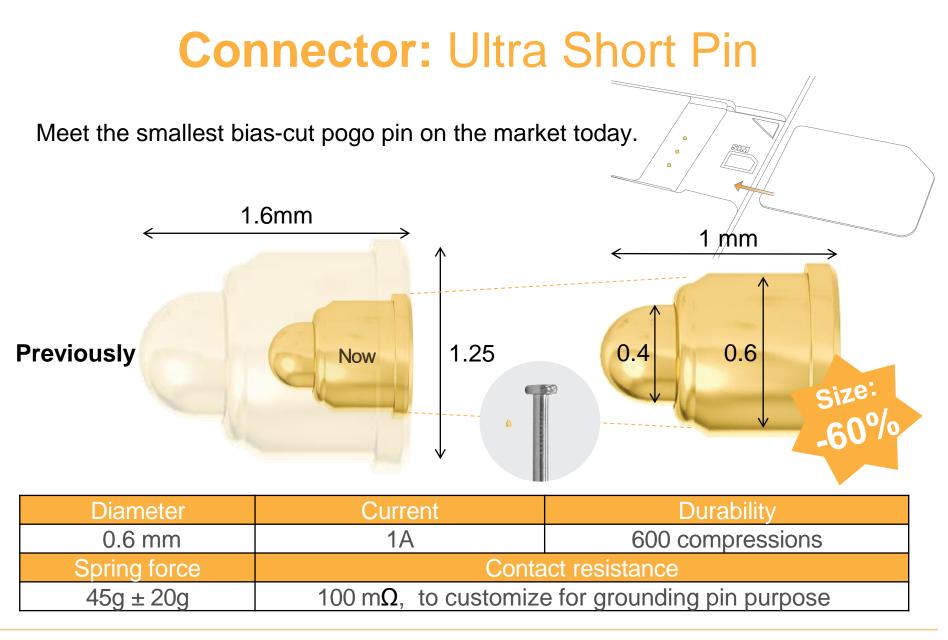
# **Connector:** 2.54mm Pitch Standard Connector Single Pitch



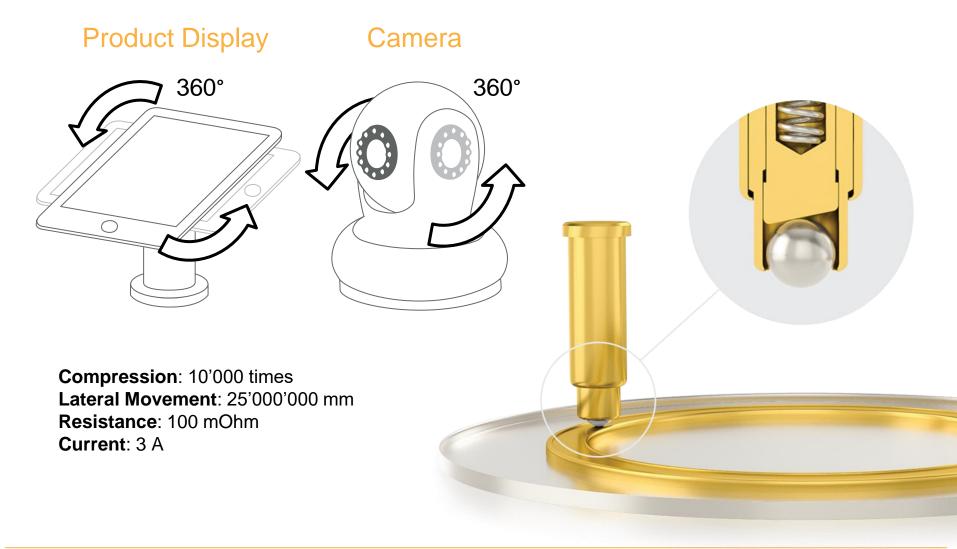
# **Connector:** 2.54mm Pitch Standard Housing

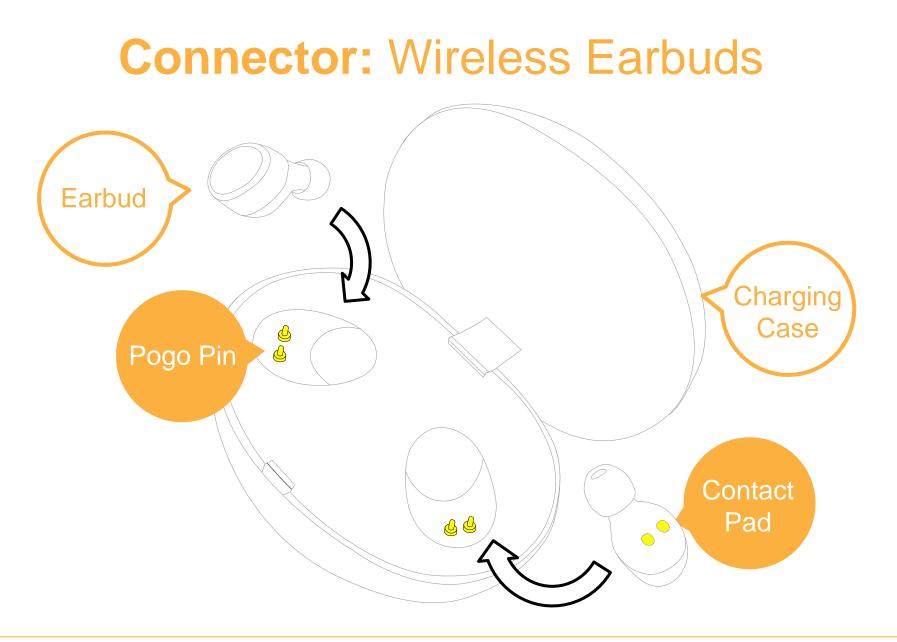


CCP – Connector: High Current Pogo



# **Connector:** Lateral Movement





# **Connector:** Computer



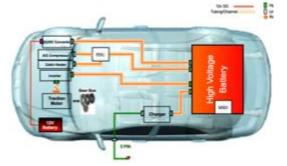
# Product Line: New Energy



**EV** Charging



**EV Inner Ports** 



### **Scooter Battery System**



### **Product Line:** Performance



# High Current: Applications



### **Charging module**

EV car charging solutions EV moped battery solutions





#### **Signal connector**

Single plug connector Multiple plug connector Push-pull connector

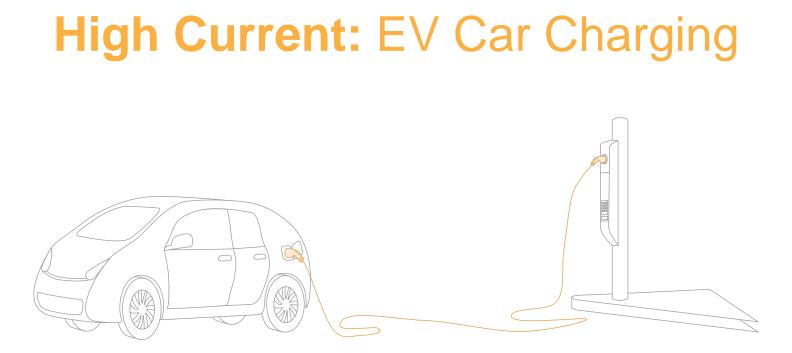




### **High voltage connector**

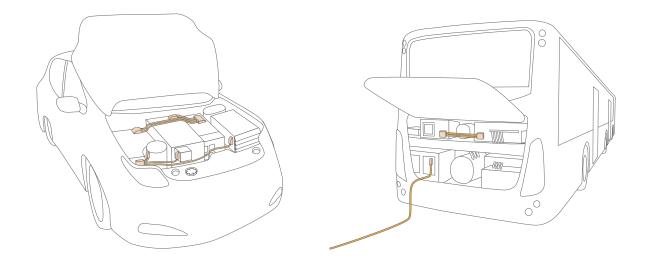
Single plug connector Multiple plug connector Push-pull connector

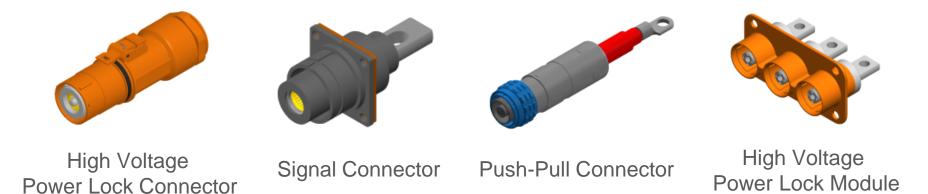




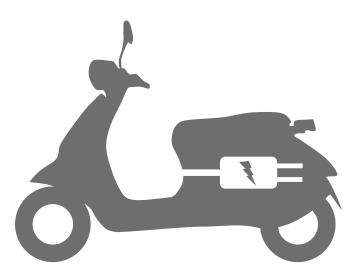


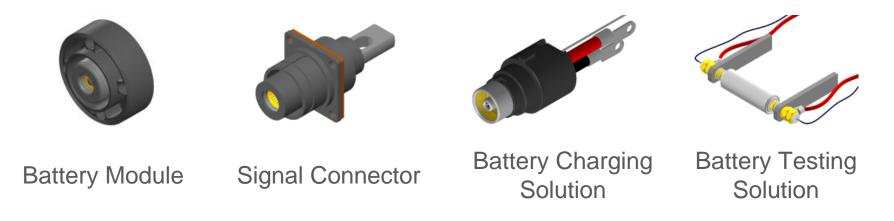
# High Current: EV Car Connections



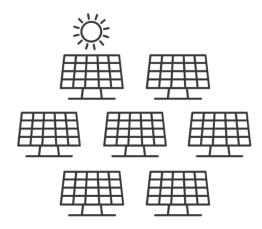


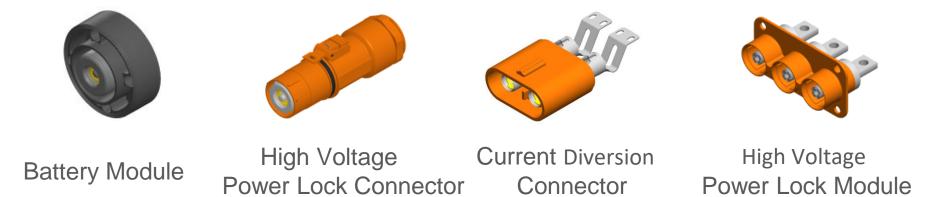
# High Current: EV Scooter Solutions

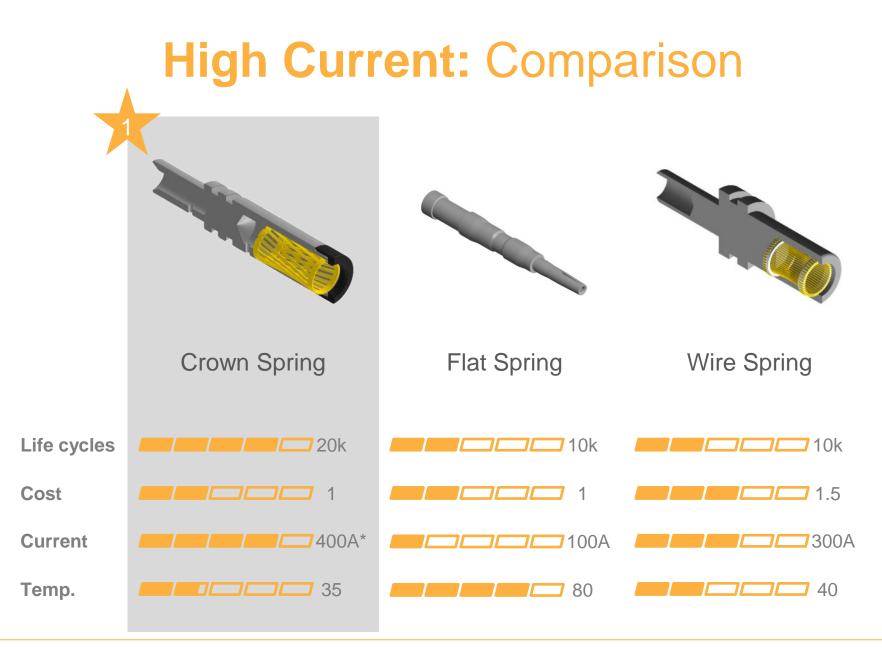




### High Current: Solar Panels and Robotics







\*Up to 600Amp

CCP - Product Line: Performance

# High Current: Comparison

Structure	Manufacturing Process		Manufacture	Durability		Current	Cost
	Socket	Contact	ability			Capacity	
Flat Spring	Lathe	Lathe	Good	Poor	Poor	Poor	Good
Crown Spring	Lathe	Stamp	Good	Good	Good	Good	Good
Wire Spring	Lathe	Wire Spring	Poor	E	Excellen	t	Poor
Spring Sets	Lathe	Spring	Poor	Poor	Poor	Poor	Poor

# High Current: Applications

	Crownspring	Socket	Plug
Material	BeCu	Cu Allo	by or Ag
Process	Stamping	Turning	by Lathe
Plating	C	Gold Plating (Ag, Au, Ni)	)
Interface	Tail with	Screw or Crimping tail of	or others
Head			Insulator Cap
Remark	Tail with	Screw or Crimping tail of	or others

# High Current: Standard Dimensions

С

	China/ Europe Standard			USA Standard		
Current (Amp)	15	30	250	2	40	80
Resistance (mOhm)	0.8	0.3	0.1	1	0.5	0.3
Life Cycles	20,000	20,000	20,000	10,000	10,000	10,000
	Dimensions					
Dim A (mm) (Width Plug)	3	6	12	1.5	2.8	3.6
Dim B (mm) sertion Hight Plug)	14.5	28.5	30.5	12	24	21
Dim C (mm) ertion Hight Socket)	32	32	42	12.9	18.7	14.6
Dim D (mm) (Width Socket)	4.8	9.8	15.8	3.1	4.9	6.73
Dim D (mm) mer Width Socket)	3.1	6.1	12.1	1.65	2.95	3.75

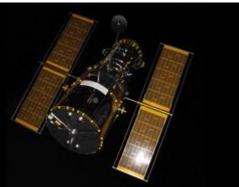
## **Product Line:** Industrial



### Transportation



Aerospace



#### Military



# Automation and Mechanical Engineering

### Inhouse Machinery Construction

Full automation capability



**100% Inspection** Pure Quality

**Clean-Room Production Line** 

### **Product Line:** Capacity

Pogo Pin Connectors



#### 60 Mio pins / month

**Testing Probes** 



2 Mio pins / month



# **Quality Management**

### **Quality System**

ISO 9001: 2015 Quality Management Systems

ISO 14001: 2015 Environmental Management System

IATF 16949: 2016 Automotive Quality Management System

> QC 080000 Hazardous Substance Process Management



# **Verification Ability**

# **Testing Items**

#### Environmental

Waterproof Humidity Test Salt Spray Thermal Impact Resist. to Solder Heat Vibration

#### Electrical

Contact Resistance Insulation HIPOT Rated Current

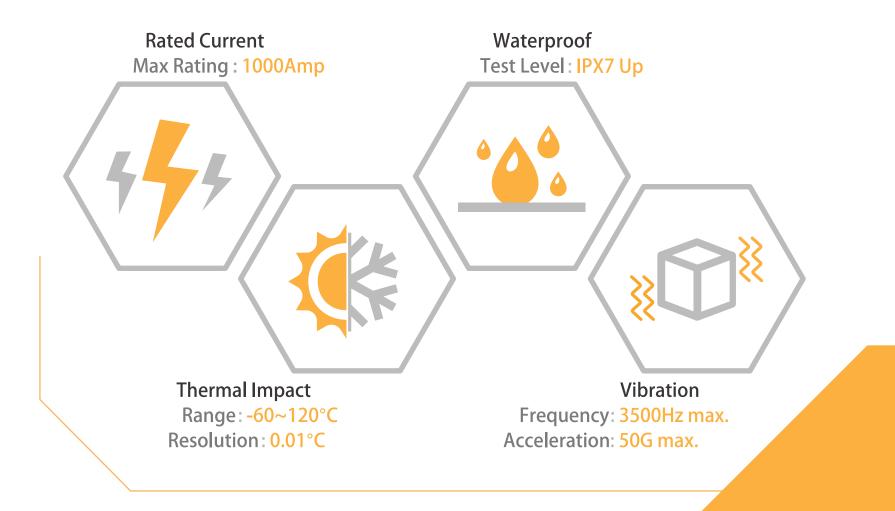
### Mechanical

Retention Force Life Cycle Vibration Mechanical Shock

#### Other

Drop Soldering Side Force Solderability

# **Testing Equipment**



### Certificate

ISO 9001 ISO 14001 ISO 14064 IATF 16949 IECQ QC080000















Contact: Ccp\_service@pccp.com.tw